These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

These assemblies are ESD sensitive, ESD precautions shall be observed.

This Assembly Note is for PCB labels only.

Size: 0.65" x 0.20"

PCB Number: COH1 COH2 COH3 COH4 COH5 COH6 COH7 COH8

Label Assembly Note

PCB Rev: DFS123812H-3000

PCB Label

COHZ8 COHZ7 COHZ6 COHZ5 COHZ4 COHZ3 COHZ2 COHZ1

<table>
<thead>
<tr>
<th>Variant</th>
<th>Label Text</th>
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<tr>
<td>001</td>
<td>SM7235-REVC</td>
</tr>
<tr>
<td>002</td>
<td>Change4Me!</td>
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Sheet Title: Hardware_ANSI-B.SchDoc

5/12/2015
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